

U402 2DL



VtkSukE eqp Ectdl t OQUHGV I4 N Channel Enhancement

Hgcvtgu

- High switching frequency
- Very low switching losses
- High voltage with low on-resistance
- Independent turn-off switching losses
- RoHS compliant

Dgpghkvu

- Cooling effort reduction
- Efficiency improvement
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency

Crnkcvkqpu

- EV motor drive
- PV string inverters
- Solar power optimizer
- Switch mode power supplies

U402 2DL p



3 Oczkwo tcvkpiu

Vcdng 4 Oczkwo tcvkpi ($T_c = 25^\circ\text{C}$ unless otherwise specified)

U{ odqn	Rctc ogvgt	Xcnwg	Wpkv	Vguv Eqpfkvkqpu	Pqvg
$V_{DS,max}$	Drain source voltage	1200	V	$V_{GS} = 0V, I_D = 100\mu A$	
$V_{GS,max}$	Gate source voltage	-8 /+22	V	Absolute maximum values	Note1
$V_{GS,pulse}$	Gate-source voltage,max. transient voltage	-10 /+25	V	$t_p = 0.5\mu s, D = 0.01$	
$V_{GS,op}$	Gate source voltage	-4 /+18	V	Recommended operational values	
I_D	Continuous drain current	97	A	$V_{GS} = 18V, T_c = 25^\circ\text{C}$	
		68		$V_{GS} = 18V, T_c = 100^\circ\text{C}$	
$I_{D(pulse)}$	Pulsed drain current	266	A	Pulse width $t_p = 100\mu s$ limited by $T_{J,max}$	
T_J, T_{stg}	Operating Junction and storage temperature	-55 to +175	$^\circ\text{C}$		

Note 1 when using MOSFET Body Diode $V_{GS,max} = -4 / +22V$

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5 Ngvegtkecn ejctcevgtkvke fkcitc ou

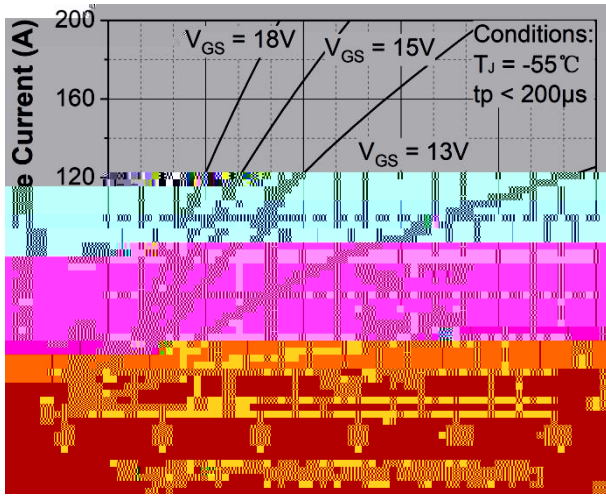


Figure 1. Output characteristics $T_J = -55^\circ\text{C}$

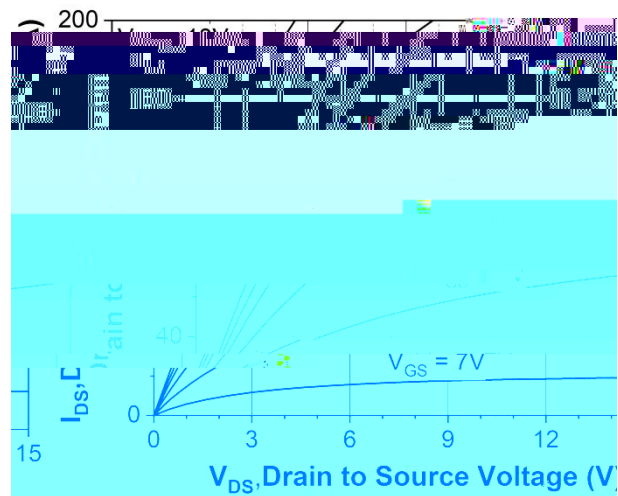


Figure 2. Output characteristics $T_J = 25^\circ\text{C}$

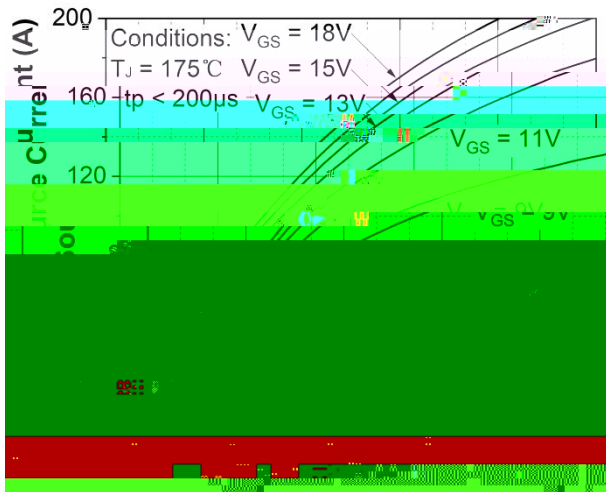


Figure 3. Output characteristics $T_J = 175^\circ\text{C}$

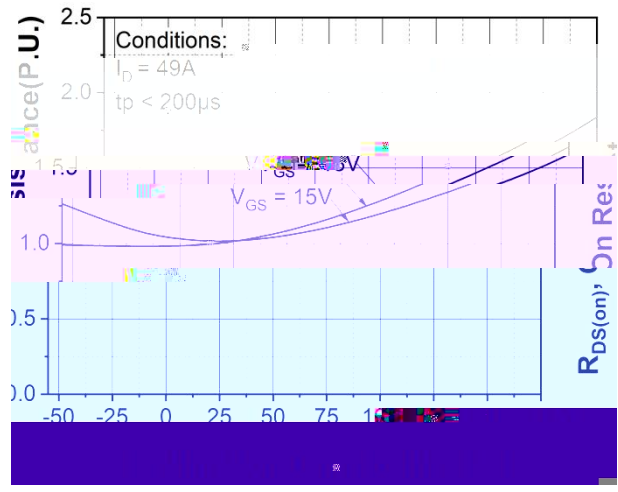


Figure 4. Normalized on-resistance vs. temperature

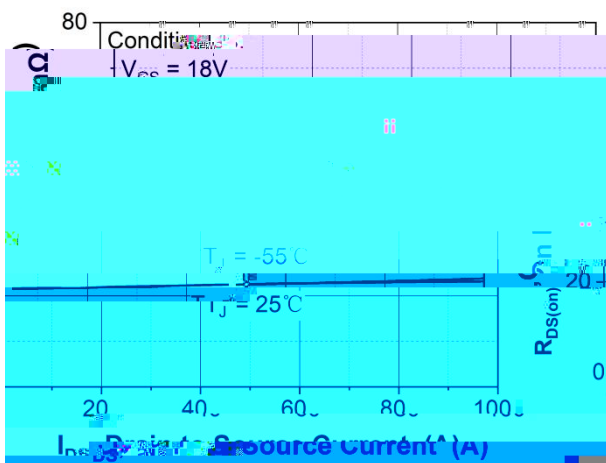


Figure 5. On-resistance vs. drain current for various temperatures

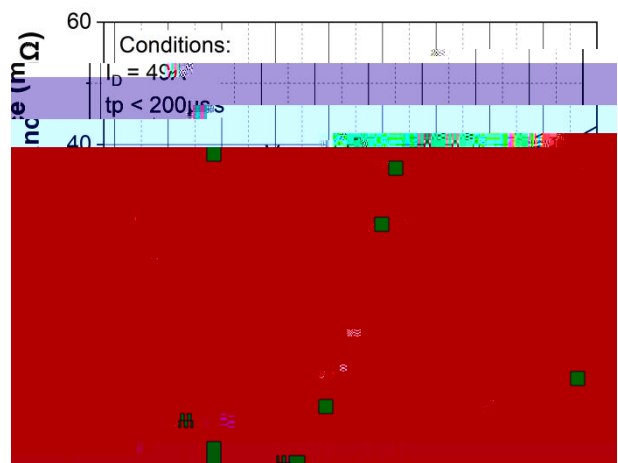


Figure 6. On-resistance vs. temperature for various gate voltage

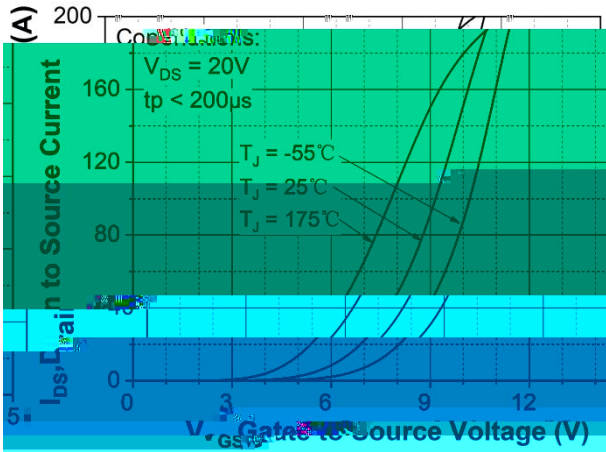


Figure 7. Transfer characteristic for various junction temperatures

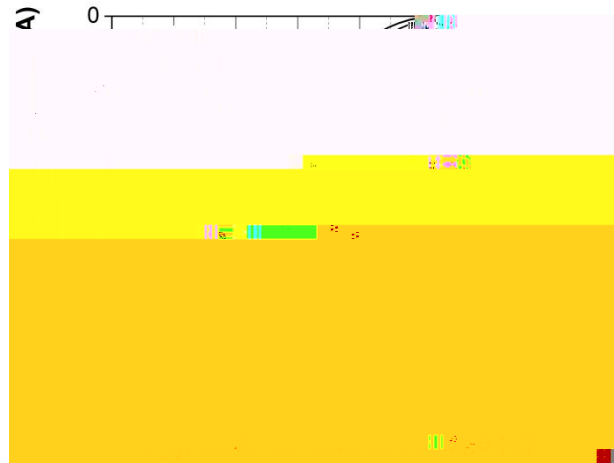


Figure 8. Body diode characteristic at $T_J = -55^\circ\text{C}$

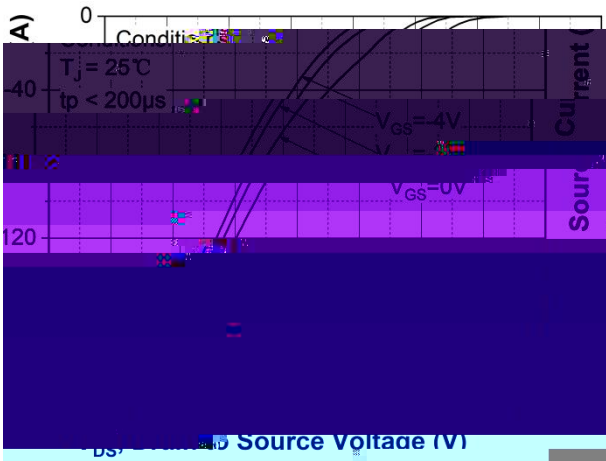


Figure 9. Body diode characteristic at $T_J = 25^\circ\text{C}$

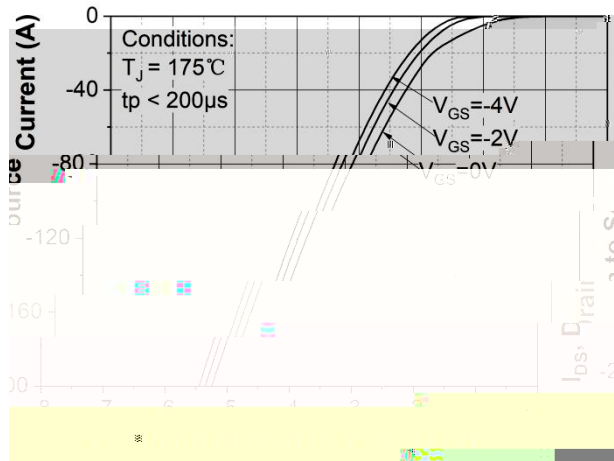


Figure 10. Body diode characteristic at $T_J = 175^\circ\text{C}$

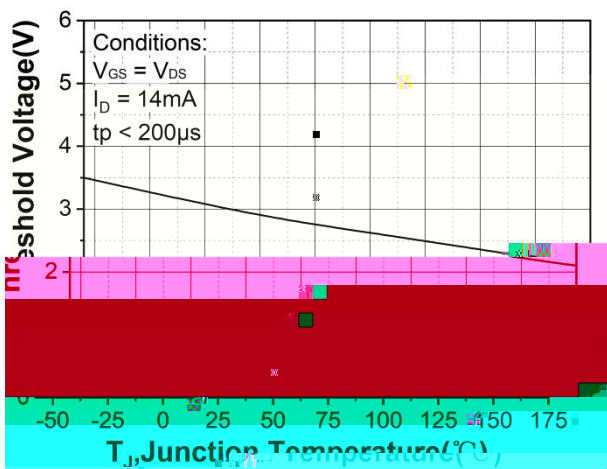


Figure 11. Threshold voltage vs. temperature

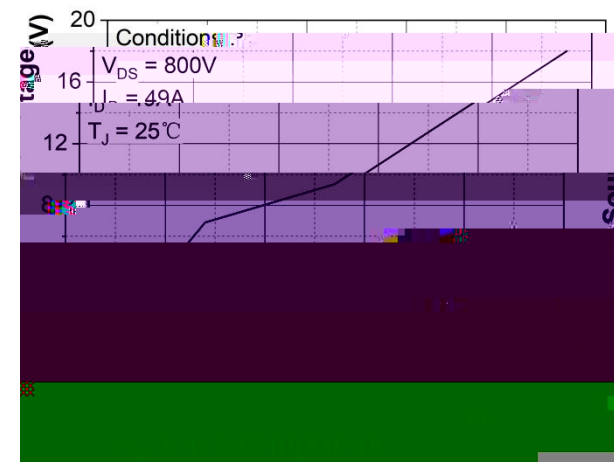


Figure 12. Gate charge characteristic

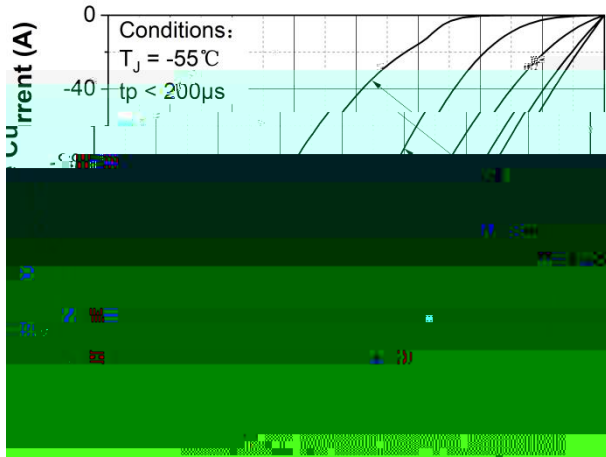


Figure 13. 3rd quadrant characteristic at $T_J = -55^\circ\text{C}$

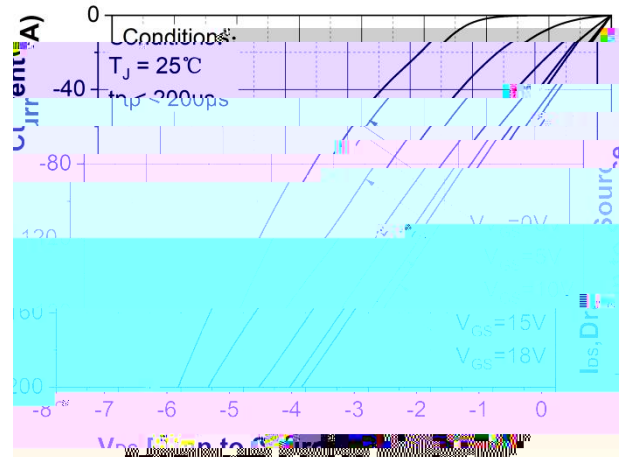


Figure 14. 3rd quadrant characteristic at $T_J = 25^\circ\text{C}$



Figure 15. 3rd quadrant characteristic at $T_J = 175^\circ\text{C}$

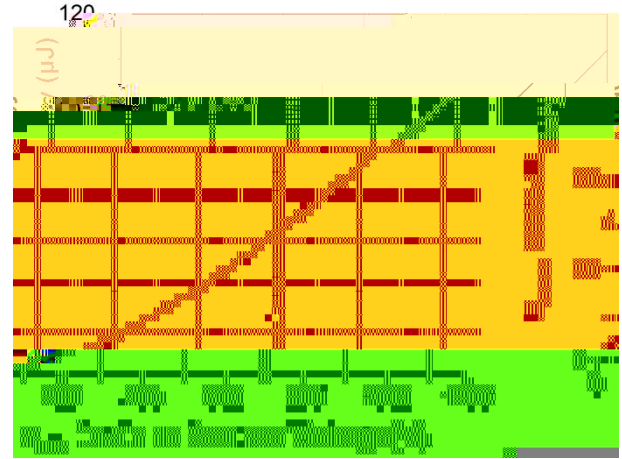


Figure 16. Output capacitor stored energy

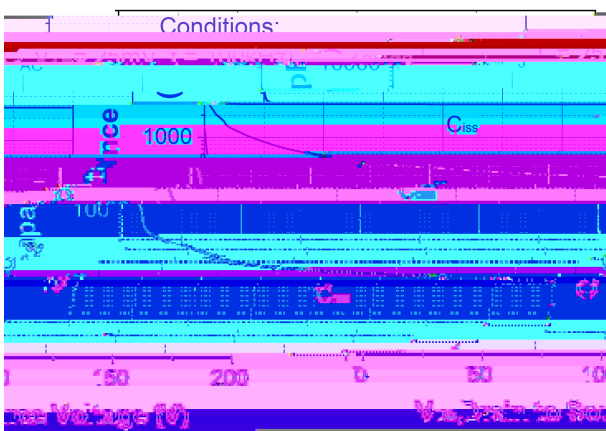


Figure 17. Capacitances vs. drain-source voltage (0 - 200V)

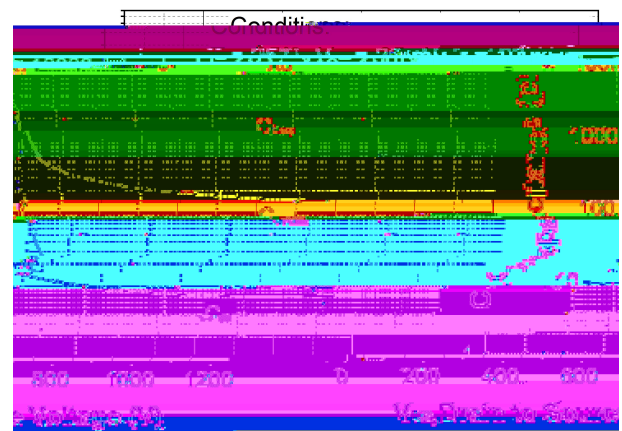


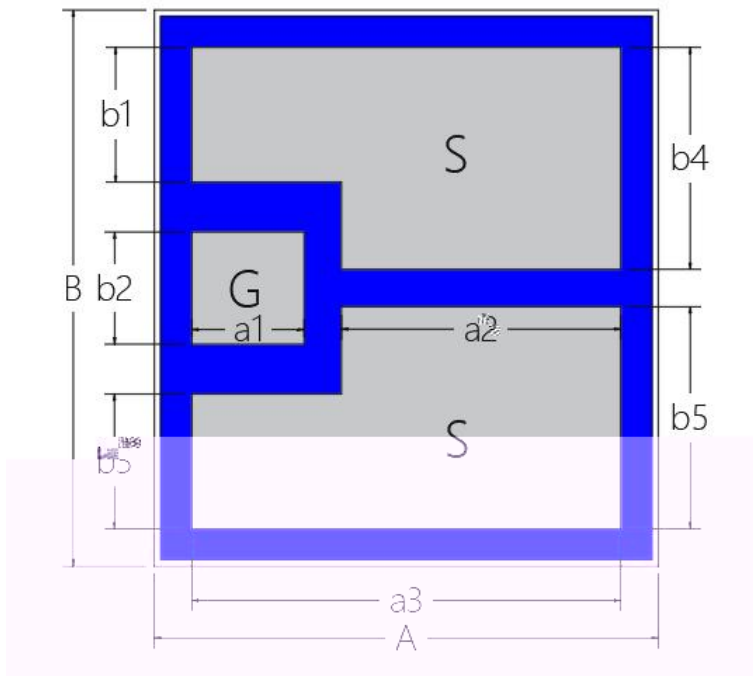
Figure 18. Capacitances vs. drain-source voltage (0 - 1200V)

6 Ogejcpkecn rctc ogvgtu

603 Fk ogpukqpu cpf ogvcnknk | cvkqp

Rctc ogvgt	V{rkecn xcnwg	Wpkv	Ogvcnknk cvkqp
Die size W x L	4.46 * 4.04	mm	
Gate pad size W x L	0.8 * 0.8	mm	
Die thickness	175	μm	
Top side source gate metallization	4	μm	Al
Back side drain metallization	1	μm	Ag

604 Nc{qww



Symbol	Dimension / mm
B	4.46
b1	1.08
b2	0.80
b3	1.08
b4	1.78
b5	1.78
A	4.04
a1	0.80
a2	2.24
a3	3.34

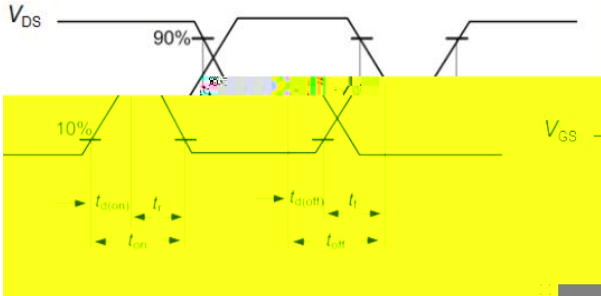


Figure A. Definition of switching times

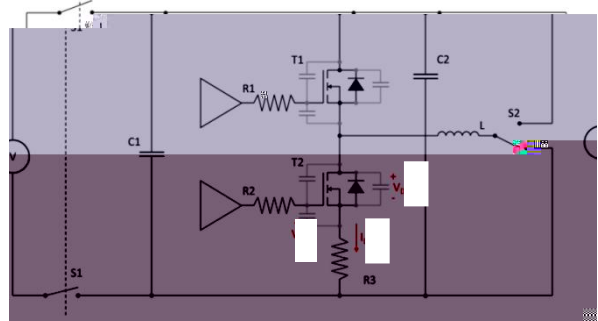


Figure B. Dynamic test circuit



Tgxkukqp j kuvqt {

Fqew o gpv xgtukqp	F cvg qh tngcug	Fqew o gpv uvc ig	Fguetkrvkqp qh ejcpigu
X23a22	4246/33/43	---	---
X23a23	4247/2:/4:	---	---
X23a24	4247/34/2:	---	---
X23a25	4247/34/44	Hkpcn	---

Cvvgpvkqp

1. TqJU eq o rnkcepg

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/ EC (RoHS2), as implemented January 2, 2013.

2. TGCEJ eq o rnkcepg

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